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Docket No.: 075834-0075

To the Director of the U. S. Patent and Trademark Office: Office: Filings and documents or the new address(es) below.

1. Name of Conveying Party(ies)

Youn Joon SUNG, Su Hee CHAE

Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies)

Name: SAMSUNG ELECTRO-MECHANICS CO., LTD.

Internal Address:

Address: 314 Maetan 3-Dong, Yeongton-Gu, Suwon, Gyunggi-Do, 443-743 REPUBLIC OF KOREA

Additional name(s) & address(es) attached? Yes No

3. Nature of Conveyance/Execution Date(s)

Execution Date(s): April 7, 2008

- Assignment Merger
- Security Agreement Change of Name
- Joint Research Agreement
- Government Interest Assignment
- Executive Order 9424, Confirmatory License
- Other

4. Application or patent number(s):

A. Patent Application No(s).

This document is being filed together with a new application

B. Patent No(s).

Additional numbers attached? Yes No

5. Name and address to whom correspondence concerning document should be mailed:

Name: MCDERMOTT WILL & EMERY LLP

Internal Address:

Street Address: 600 13th Street, N.W.

City: Washington State: D. C. Zip: 20005-3096

Phone Number: 202.756.8000

Fax Number: 202.756.8087

Email Address:

6. Total number of applications and patents involved:

7. Total fee (37 CFR 1.21(h) & 3.41) \$40.00

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9. Signature.

Hosang Lee

April 30, 2008

Name and Registration No. of Person Signing

Signature

Date

Total number of pages including cover sheet, attachments and documents: 2

(SAB)
Docket No.: _____

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

- (1) SUNG Youn Joon
- (2) CHAE Su Hee

who have made a certain new and useful invention, hereby sell, assign and transfer unto

SAMSUNG Electro-Mechanics Co., Ltd.
314 Maetan 3-Dong, Yeongtong-Gu,
Suwon, Gyunggi-Do
Republic of KOREA
Postal Code: 443-743

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States America as defined in 35 U.S.C. 100 in the invention entitled

METHOD OF ISOLATING SEMICONDUCTOR LASER DIODES

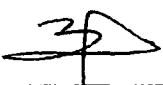

(a) for which an application for United States Letters Patent was filed on _____, a identified by United States Serial No. _____; or

(b) for which an application for United States Letters Patent was executed on _____

and the undersigned hereby authorize and request the United States Commissioner of Patents and Trademarks to issue a and all United States Letters Patent which may be granted therefor and any and all extensions, divisions, reissues substitutes, renewals, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors assigns and legal representatives; the undersigned agree that the attorneys of record in said application shall hereafter act behalf of said ASSIGNEE;

AND the undersigned hereby agree to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's protection and title in and to the invention hereby transferred.

SIGNED on the dates indicated beside our signatures:

INVENTORS	DATE SIGNED
1)  _____ Name: SUNG Youn Joon	_____ 04/07/2008
2)  _____ Name: CHAE Su Hee	_____ 04/07/2008

PATENT